

To our customers,

Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

Send any inquiries to <http://www.renesas.com/inquiry>.

Notice

1. All information included in this document is current as of the date this document is issued. Such information, however, is subject to change without any prior notice. Before purchasing or using any Renesas Electronics products listed herein, please confirm the latest product information with a Renesas Electronics sales office. Also, please pay regular and careful attention to additional and different information to be disclosed by Renesas Electronics such as that disclosed through our website.
2. Renesas Electronics does not assume any liability for infringement of patents, copyrights, or other intellectual property rights of third parties by or arising from the use of Renesas Electronics products or technical information described in this document. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
3. You should not alter, modify, copy, or otherwise misappropriate any Renesas Electronics product, whether in whole or in part.
4. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation of these circuits, software, and information in the design of your equipment. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from the use of these circuits, software, or information.
5. When exporting the products or technology described in this document, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations. You should not use Renesas Electronics products or the technology described in this document for any purpose relating to military applications or use by the military, including but not limited to the development of weapons of mass destruction. Renesas Electronics products and technology may not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations.
6. Renesas Electronics has used reasonable care in preparing the information included in this document, but Renesas Electronics does not warrant that such information is error free. Renesas Electronics assumes no liability whatsoever for any damages incurred by you resulting from errors in or omissions from the information included herein.
7. Renesas Electronics products are classified according to the following three quality grades: “Standard”, “High Quality”, and “Specific”. The recommended applications for each Renesas Electronics product depends on the product’s quality grade, as indicated below. You must check the quality grade of each Renesas Electronics product before using it in a particular application. You may not use any Renesas Electronics product for any application categorized as “Specific” without the prior written consent of Renesas Electronics. Further, you may not use any Renesas Electronics product for any application for which it is not intended without the prior written consent of Renesas Electronics. Renesas Electronics shall not be in any way liable for any damages or losses incurred by you or third parties arising from the use of any Renesas Electronics product for an application categorized as “Specific” or for which the product is not intended where you have failed to obtain the prior written consent of Renesas Electronics. The quality grade of each Renesas Electronics product is “Standard” unless otherwise expressly specified in a Renesas Electronics data sheets or data books, etc.
 - “Standard”: Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; and industrial robots.
 - “High Quality”: Transportation equipment (automobiles, trains, ships, etc.); traffic control systems; anti-disaster systems; anti-crime systems; safety equipment; and medical equipment not specifically designed for life support.
 - “Specific”: Aircraft; aerospace equipment; submersible repeaters; nuclear reactor control systems; medical equipment or systems for life support (e.g. artificial life support devices or systems), surgical implantations, or healthcare intervention (e.g. excision, etc.), and any other applications or purposes that pose a direct threat to human life.
8. You should use the Renesas Electronics products described in this document within the range specified by Renesas Electronics, especially with respect to the maximum rating, operating supply voltage range, movement power voltage range, heat radiation characteristics, installation and other product characteristics. Renesas Electronics shall have no liability for malfunctions or damages arising out of the use of Renesas Electronics products beyond such specified ranges.
9. Although Renesas Electronics endeavors to improve the quality and reliability of its products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Further, Renesas Electronics products are not subject to radiation resistance design. Please be sure to implement safety measures to guard them against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a Renesas Electronics product, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult, please evaluate the safety of the final products or system manufactured by you.
10. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. Please use Renesas Electronics products in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. Renesas Electronics assumes no liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
11. This document may not be reproduced or duplicated, in any form, in whole or in part, without prior written consent of Renesas Electronics.
12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products, or if you have any other inquiries.

(Note 1) “Renesas Electronics” as used in this document means Renesas Electronics Corporation and also includes its majority-owned subsidiaries.

(Note 2) “Renesas Electronics product(s)” means any product developed or manufactured by or for Renesas Electronics.

4571 Group

Input/Output Ports

1. Abstract

This document shows an example of how to set the input/output ports of the 4571 group of Renesas microcomputers and an application example of using those pins.

2. Introduction

The application example explained in this document is applied for use with the microcomputers and under the conditions described below.

- Microcomputer: 4571 group

Please note that some sample programs available from Renesas involve manipulating the bits of unused functions for reasons of bit arrangement in the control registers. The values of these bits in a user system should be set to suit the usage condition of the system.

3. Input/Output Ports

3.1 Port P0

Port P0 permits 4 bits of data to be input or output to and from the port.

The key-on wakeup function and the pullup transistor function of this port can be turned on or off by setting up the register K0 and register PU0, respectively.

3.1.1 Port P0 Input/Output Method

- Input method

For port P0i (i = 0-3) to be used, set the corresponding output latch to 1 using the OP0A instruction. If the output latch is set to 0, a low-level signal will be input.

When the IAP0 instruction is executed, the pin state of port P0 is transferred to the register A.

- Output method

The content of register A is output to port P0 by the OP0A instruction.

3.2 Port P1

Port P1 permits 4 bits of data to be input or output to and from the port.

The key-on wakeup function and the pullup transistor function of this port can be turned on or off by setting up the register K1 and register PU1, respectively.

3.2.1 Port P1 Input/Output Method

- Input method

For port P1i (i = 0-3) to be used, set the corresponding output latch to 1 using the OP1A instruction. If the output latch is set to 0, a low-level signal will be input.

When the IAP1 instruction is executed, the pin state of port P1 is transferred to the register A.

- Output method

The content of register A is output to port P1 by the OP1A instruction.

3.3 Port P2

Port P2 permits 2 bits of data to be input or output to and from the port. Port P20 and P21 are shared with the interrupt input pins INT0 and INT1, respectively.

The key-on wakeup function and the pullup transistor function of this port can be turned on or off by setting up the registers K21 and K20 and registers PU21 and PU20, respectively.

Furthermore, the return condition or the active waveform level of the INT input pin-based key-on wakeup function can be selected by setting up the register L.

3.3.1 Port P2 Input/Output Method

- Input method

For port P2i (i = 0, 1) to be used, set the corresponding output latch to 1 using the OP2A instruction. If the output latch is set to 0, a low-level signal will be input.

When the IAP2 instruction is executed, the pin state of port P2 is transferred to the register A.

- Output method

The content of register A is output to port P2 by the OP2A instruction.

3.4 Port P3

Port P3 permits 2 bits of data to be input or output to and from the port.

Furthermore, the port output mode can be selected between N-channel open-drain output and CMOS output by setting up the registers FR00 and FR01.

3.4.1 Port P3 Input/Output Method

- Input method

For port P3i (i = 0-3) to be used, first set the corresponding registers FR00-FR01 to 0 and then set the corresponding output latch to 1 using the OP3A instruction. If the output latch is set to 0, a low-level signal will be input.

When the IAP3 instruction is executed, the pin state of port P3 is transferred to the register A.

- Output method

The content of register A is output to port P3 by the OP3A instruction.

The output mode of this port can be selected between N-channel open-drain output and CMOS output bitwise by setting up the registers FR00-FR01.

3.5 Port D

Port D permits 5 bits of data to be input or output bitwise to and from the port. Port D4 is shared with the CNTR0 pin.

Furthermore, the output mode of port D0-D3 can be selected between N-channel open-drain output and CMOS output by setting up the register FR1.

3.5.1 Port D Input/Output Method

Port D controls input/output of data bitwise, or one bit at a time. Therefore, if data is to be input/output on port D0-D4, one line of port D must first be selected with the data pointer register Y.

- Input method

For port D0-D3 to be used, first set the corresponding register FR1i (i = 0-3) to 0 and then set the output latch of port Di (i = 0-3) to 1 using the SD instruction. If the output latch is set to 0, a low-level signal will be input.

For port D4, set its output latch to 1 using the SD instruction. If the output latch is set to 0, a low-level signal will be input.

When the SZD instruction is executed, if the content of the port specified by the register Y is 0, the next instruction is skipped; if 1, the next instruction is executed.

- Output method

Set the output level in the output latch using the SD and RD instructions.

The output mode of port D0-D3 can be selected between N-channel open-drain output and CMOS output bitwise by setting up the register FR1.

When the SD instruction is executed, the port pin goes to a high-impedance or a high-level state.

When the CLD instruction is executed, all pins of port D go to a high-impedance or a high-level state.

When the RD instruction is executed, the port pin goes to a low-level state.

Note 1: When using the SD and RD instructions, do not set any value equal to or greater than “01012” in the register Y.

Note 2: Port D4 is shared with CNTR0. Therefore, if this port pin needs to be used as port D4, set register W50 to 0.

3.6 Port C

Port C permits 1 bit of data to be output from the port. Port C is shared with the CNTR1 pin.

3.6.1 Port C Output Method

- Output method

The output mode of this port is CMOS. When the SCP instruction is executed, the port pin goes to a high-level state.

When the RCP instruction is executed, the port pin goes to a low-level state.

3.7 Port K

Port K permits 1 bit of data to be input through the port.

The key-on wakeup function of this port can be turned on or off by setting up the register K22.

3.7.1 Port K Input Method

- Input method

When the IAK instruction is executed, the pin state of port K is transferred to the least significant bit (A0) of the register A.

The content of 3 high-order bits (A3-A1) of the register A is 0.

4. Related Registers

4.1 Timer Control Register W5

Table 4.1 shows the Bit Configuration of Timer Control Register W5.

For write to the register W5, first set a value in the register A and then use the TW5A instruction.

Furthermore, the TAW5 instruction may be used to transfer the content of the register W5 to the register A.

Table 4.1 Bit Configuration of Timer Control Register W5

Timer Control Register W5		When reset: 0000 ₂	When RAM backed-up: State retained	R/W TAW5/TW5A
W5 ₃	Timer 1 count start sync circuit select bit Note 2	0	Does not select timer 1 count start sync circuit	
		1	Selects timer 1 count start sync circuit	
W5 ₂	CNTR0 pin input count edge select bit	0	Falling edge	
		1	Rising edge	
W5 ₁	CNTR1 pin output auto control circuit select bit	0	Does not select CNTR1 pin output auto control circuit	
		1	Selects CNTR1 pin output auto control circuit	
W5 ₀	D4/CNTR0 pin function select bit	0	D4 output/CNTR0 input	
		1	D4 input/CNTR0 output	

Note 1: The letter R denotes “readable,” and the letter W denotes “writable.”

Note 2: This function is usable only when INT0 pin timer 1 control is enabled (I10 = 1).

Note 3: : Unused bits during port setting

4.2 Pullup Control Register PU0

Table 4.2 shows the Bit Configuration of Pullup Control Register PU0.

For write to the register PU0, first set a value in the register A and then use the TPU0 instruction.

Furthermore, the TAPU0 instruction may be used to transfer the content of the register PU0 to the register A.

Table 4.2 Bit Configuration of Pullup Control Register PU0

Pullup Control Register PU0		When reset: 0000 ₂	When RAM backed-up: State retained	R/W TAPU0/TPU0A
PU0 ₃	Port P0 ₃ pullup transistor control bit	0	Turns pullup transistor off	
		1	Turns pullup transistor on	
PU0 ₂	Port P0 ₂ pullup transistor control bit	0	Turns pullup transistor off	
		1	Turns pullup transistor on	
PU0 ₁	Port P0 ₁ pullup transistor control bit	0	Turns pullup transistor off	
		1	Turns pullup transistor on	
PU0 ₀	Port P0 ₀ pullup transistor control bit	0	Turns pullup transistor off	
		1	Turns pullup transistor on	

Note 1: The letter R denotes “readable,” and the letter W denotes “writable.”

4.3 Pullup Control Register PU1

Table 4.3 shows the Bit Configuration of Pullup Control Register PU1.

For write to the register PU1, first set a value in the register A and then use the TPU1 instruction.

Furthermore, the TAPU1 instruction may be used to transfer the content of the register PU1 to the register A.

Table 4.3 Bit Configuration of Pullup Control Register PU1

Pullup Control Register PU1		When reset: 00002	When RAM backed-up: State retained	R/W TAPU1/TPU1A
PU13	Port P13 pullup transistor control bit	0	Turns pullup transistor off	
		1	Turns pullup transistor on	
PU12	Port P12 pullup transistor control bit	0	Turns pullup transistor off	
		1	Turns pullup transistor on	
PU11	Port P11 pullup transistor control bit	0	Turns pullup transistor off	
		1	Turns pullup transistor on	
PU10	Port P10 pullup transistor control bit	0	Turns pullup transistor off	
		1	Turns pullup transistor on	

Note 1: The letter R denotes “readable,” and the letter W denotes “writable.”

4.4 Pullup Control Register PU2

Table 4.4 shows the Bit Configuration of Pullup Control Register PU2.

For write to the register PU2, first set a value in the register A and then use the TPU2 instruction.

Furthermore, the TAPU2 instruction may be used to transfer the content of the register PU2 to the register A.

Table 4.4 Bit Configuration of Pullup Control Register PU2

Pullup Control Register PU2		When reset: 00002	When RAM backed-up: State retained	R/W TAPU2/TPU2A
PU23	Unused	0	This bit has no functions, but can be accessed for read/write.	
		1		
PU22	Unused	0	This bit has no functions, but can be accessed for read/write.	
		1		
PU21	Port P21 pullup transistor control bit	0	Turns pullup transistor off	
		1	Turns pullup transistor on	
PU20	Port P20 pullup transistor control bit	0	Turns pullup transistor off	
		1	Turns pullup transistor on	

Note 1: The letter R denotes “readable,” and the letter W denotes “writable.”

Note 2: : Unused bits during port setting

4.5 Port Output Mode Control Register FR0

Table 4.5 shows the Bit Configuration of Port Output Mode Control Register FR0.

For write to the register FR0, first set a value in the register A and then use the TFR0A instruction.

Table 4.5 Bit Configuration of Port Output Mode Control Register FR0

Port Output Mode Control Register FR0		When reset: 0000 ₂	When RAM backed-up: State retained	W TFR0A
FR0 ₃	Unused	0	This bit has no functions, but can be accessed for read/write.	
		1		
FR0 ₂	Unused	0	This bit has no functions, but can be accessed for read/write.	
		1		
FR0 ₁	Port P3 ₁ output mode select bit	0	N-channel open-drain output	
		1	CMOS output	
FR0 ₀	Port P3 ₀ output mode select bit	0	N-channel open-drain output	
		1	CMOS output	

Note 1: The letter W denotes “writable.”

Note 2: : Unused bits during port setting

4.6 Port Output Mode Control Register FR1

Table 4.6 shows the Bit Configuration of Port Output Mode Control Register FR1.

For write to the register FR1, first set a value in the register A and then use the TFR1A instruction.

Table 4.6 Bit Configuration of Port Output Mode Control Register FR1

Port Output Mode Control Register FR1		When reset: 0000 ₂	When RAM backed-up: State retained	W TFR1A
FR1 ₃	Port D3 output mode select bit	0	N-channel open-drain output	
		1	CMOS output	
FR1 ₂	Port D2 output mode select bit	0	N-channel open-drain output	
		1	CMOS output	
FR1 ₁	Port D1 output mode select bit	0	N-channel open-drain output	
		1	CMOS output	
FR1 ₀	Port D0 output mode select bit	0	N-channel open-drain output	
		1	CMOS output	

Note 1: The letter W denotes “writable.”

4.7 Key-on Wakeup Control Register K0

Table 4.7 shows the Bit Configuration of Key-on Wakeup Control Register K0.

For write to the register K0, first set a value in the register A and then use the TK0A instruction.

Furthermore, the TAK0 instruction may be used to transfer the content of the register K0 to the register A.

Table 4.7 Bit Configuration of Key-on Wakeup Control Register K0

Key-on Wakeup Control Register K0		When reset: 00002	When RAM backed-up: State retained	R/W TAK0/TK0A
K03	Port P03 key-on wakeup control bit	0	Disables key-on wakeup	
		1	Enables key-on wakeup	
K02	Port P02 key-on wakeup control bit	0	Disables key-on wakeup	
		1	Enables key-on wakeup	
K01	Port P01 key-on wakeup control bit	0	Disables key-on wakeup	
		1	Enables key-on wakeup	
K00	Port P00 key-on wakeup control bit	0	Disables key-on wakeup	
		1	Enables key-on wakeup	

Note 1: The letter R denotes “readable,” and the letter W denotes “writable.”

4.8 Key-on Wakeup Control Register K1

Table 4.8 shows the Bit Configuration of Key-on Wakeup Control Register K1.

For write to the register K1, first set a value in the register A and then use the TK1A instruction.

Furthermore, the TAK1 instruction may be used to transfer the content of the register K1 to the register A.

Table 4.8 Bit Configuration of Key-on Wakeup Control Register K1

Key-on Wakeup Control Register K1		When reset: 00002	When RAM backed-up: State retained	R/W TAK1/TK1A
K13	Port P13 key-on wakeup control bit	0	Disables key-on wakeup	
		1	Enables key-on wakeup	
K12	Port P12 key-on wakeup control bit	0	Disables key-on wakeup	
		1	Enables key-on wakeup	
K11	Port P11 key-on wakeup control bit	0	Disables key-on wakeup	
		1	Enables key-on wakeup	
K10	Port P10 key-on wakeup control bit	0	Disables key-on wakeup	
		1	Enables key-on wakeup	

Note 1: The letter R denotes “readable,” and the letter W denotes “writable.”

4.9 Key-on Wakeup Control Register K2

Table 4.9 shows the Bit Configuration of Key-on Wakeup Control Register K2.

For write to the register K2, first set a value in the register A and then use the TK2A instruction.

Furthermore, the TAK2 instruction may be used to transfer the content of the register K2 to the register A.

Table 4.9 Bit Configuration of Key-on Wakeup Control Register K2

Key-on Wakeup Control Register K2		When reset: 0000z	When RAM backed-up: State retained	R/W TAK2/TK2A
K23	Unused	0	This bit has no functions, but can be accessed for read/write.	
		1		
K22	Port K key-on wakeup control bit	0	Disables key-on wakeup	
		1	Enables key-on wakeup	
K21	Port P21 key-on wakeup control bit	0	Disables key-on wakeup	
		1	Enables key-on wakeup	
K20	Port P20 key-on wakeup control bit	0	Disables key-on wakeup	
		1	Enables key-on wakeup	

Note 1: The letter R denotes “readable,” and the letter W denotes “writable.”

Note 2: : Unused bits during port setting

4.10 Key-on Wakeup Control Register L1

Table 4.10 shows the Bit Configuration of Key-on Wakeup Control Register L1.

For write to the register L1, first set a value in the register A and then use the TL1A instruction.

Furthermore, the TAL1 instruction may be used to transfer the content of the register L1 to the register A.

Table 4.10 Bit Configuration of Key-on Wakeup Control Register L1

Key-on Wakeup Control Register L1		When reset: 0000z	When RAM backed-up: State retained	R/W TAL1/TL1A
L13	INT1 pin return condition select bit	0	Level returned	
		1	Edge returned	
L12	INT1 pin active waveform level select bit	0	Disables key-on wakeup	
		1	Enables key-on wakeup	
L11	INT0 pin return condition select bit	0	Level returned	
		1	Edge returned	
L10	INT0 pin key-on wakeup control bit	0	Disables key-on wakeup	
		1	Enables key-on wakeup	

Note 1: The letter R denotes “readable,” and the letter W denotes “writable.”

5. Port Application Example

5.1 Key Input by Key Scan

When N-channel open-drain output is selected for the output mode of port D and the internal pullup transistor of port P0 is used, a key matrix can be configured by connecting an external circuit comprised of only keys to the chip.

Point: The external component needed for this application consists of only keys.

Specification: Port D outputs a low-level signal, and port P0 accepts 16 keys as its input.

Figure 5.1 shows an Example of a Key Matrix Circuit. Figure 5.2 shows Key Scan Input Timing.

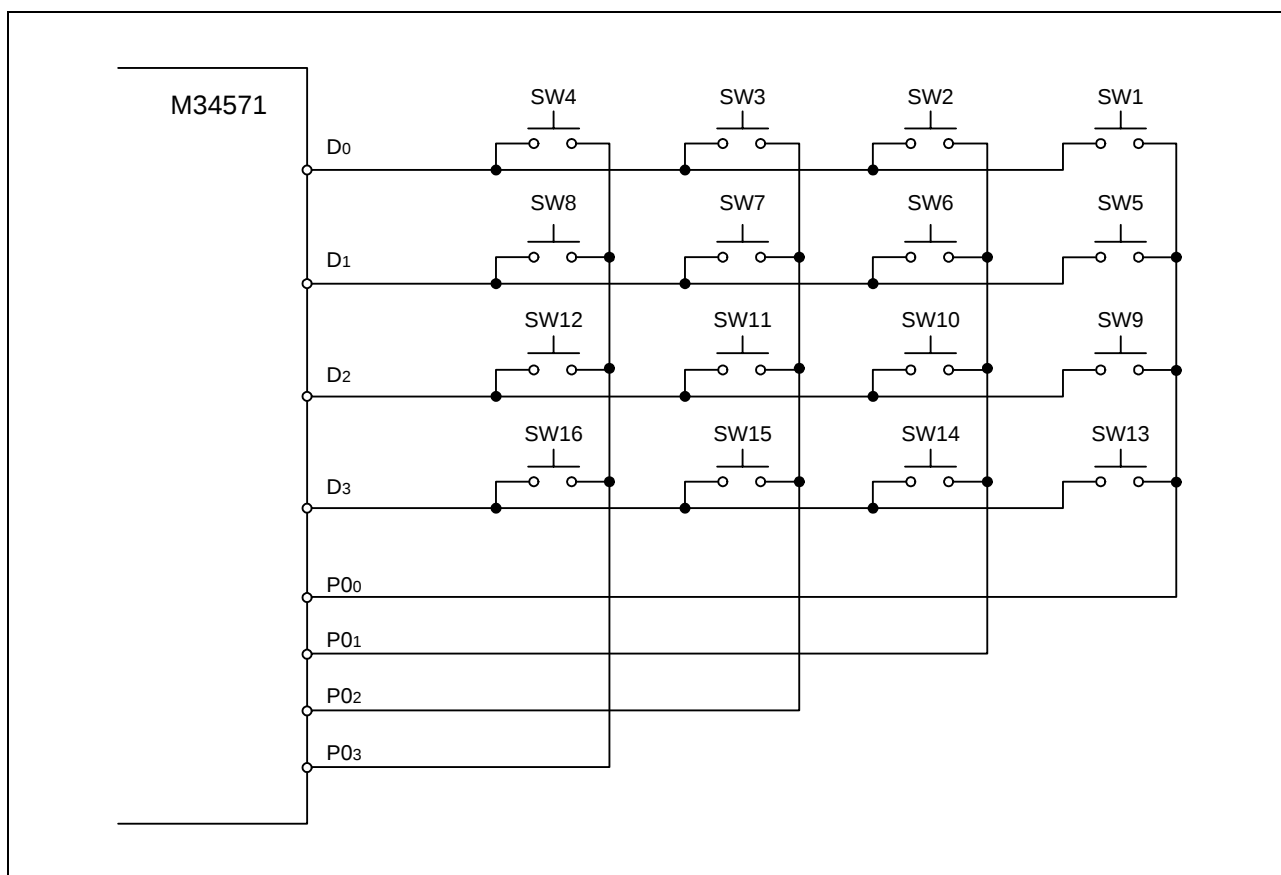
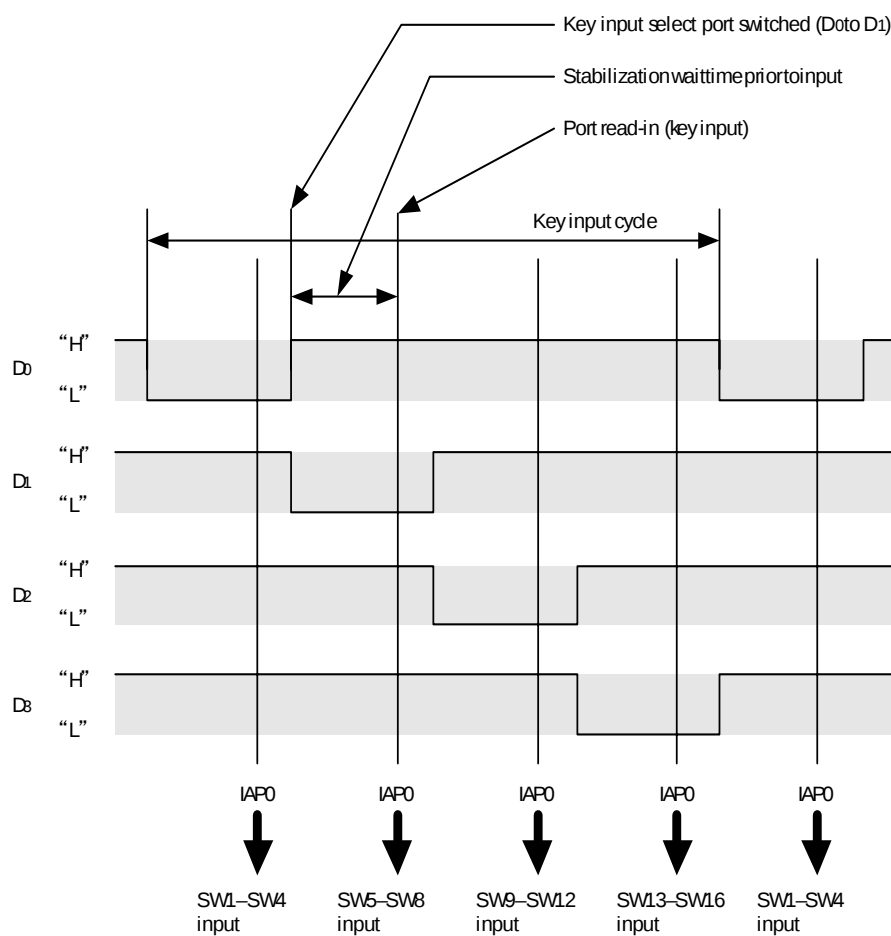


Figure 5.1 Example of a Key Matrix Circuit



Note: High-level output on port D goes to a high-impedance state.

Figure 5.2 Key Scan Input Timing

6. Reference Documents

Data sheet

4571 Group Data Sheet

The latest version is available from the Renesas Technology Web site.

7. Renesas Web Site and Where to Contact

Renesas Technology Web site:

<http://japan.renesas.com/>

Where to contact:

<http://japan.renesas.com/inquiry>

csc@renesas.com

Revision history	4571 Group Input/Output Ports Application Note
------------------	---

Rev.	Date	Description	
		Page	Points
1.00	2006.08.01	-	First edition issued

Notes regarding these materials

1. This document is provided for reference purposes only so that Renesas customers may select the appropriate Renesas products for their use. Renesas neither makes warranties or representations with respect to the accuracy or completeness of the information contained in this document nor grants any license to any intellectual property rights or any other rights of Renesas or any third party with respect to the information in this document.
2. Renesas shall have no liability for damages or infringement of any intellectual property or other rights arising out of the use of any information in this document, including, but not limited to, product data, diagrams, charts, programs, algorithms, and application circuit examples.
3. You should not use the products or the technology described in this document for the purpose of military applications such as the development of weapons of mass destruction or for the purpose of any other military use. When exporting the products or technology described herein, you should follow the applicable export control laws and regulations, and procedures required by such laws and regulations.
4. All information included in this document such as product data, diagrams, charts, programs, algorithms, and application circuit examples, is current as of the date this document is issued. Such information, however, is subject to change without any prior notice. Before purchasing or using any Renesas products listed in this document, please confirm the latest product information with a Renesas sales office. Also, please pay regular and careful attention to additional and different information to be disclosed by Renesas such as that disclosed through our website. (<http://www.renesas.com>)
5. Renesas has used reasonable care in compiling the information included in this document, but Renesas assumes no liability whatsoever for any damages incurred as a result of errors or omissions in the information included in this document.
6. When using or otherwise relying on the information in this document, you should evaluate the information in light of the total system before deciding about the applicability of such information to the intended application. Renesas makes no representations, warranties or guarantees regarding the suitability of its products for any particular application and specifically disclaims any liability arising out of the application and use of the information in this document or Renesas products.
7. With the exception of products specified by Renesas as suitable for automobile applications, Renesas products are not designed, manufactured or tested for applications or otherwise in systems the failure or malfunction of which may cause a direct threat to human life or create a risk of human injury or which require especially high quality and reliability such as safety systems, or equipment or systems for transportation and traffic, healthcare, combustion control, aerospace and aeronautics, nuclear power, or undersea communication transmission. If you are considering the use of our products for such purposes, please contact a Renesas sales office beforehand. Renesas shall have no liability for damages arising out of the uses set forth above.
8. Notwithstanding the preceding paragraph, you should not use Renesas products for the purposes listed below:
 - (1) artificial life support devices or systems
 - (2) surgical implantations
 - (3) healthcare intervention (e.g., excision, administration of medication, etc.)
 - (4) any other purposes that pose a direct threat to human life

Renesas shall have no liability for damages arising out of the uses set forth in the above and purchasers who elect to use Renesas products in any of the foregoing applications shall indemnify and hold harmless Renesas Technology Corp., its affiliated companies and their officers, directors, and employees against any and all damages arising out of such applications.
9. You should use the products described herein within the range specified by Renesas, especially with respect to the maximum rating, operating supply voltage range, movement power voltage range, heat radiation characteristics, installation and other product characteristics. Renesas shall have no liability for malfunctions or damages arising out of the use of Renesas products beyond such specified ranges.
10. Although Renesas endeavors to improve the quality and reliability of its products, IC products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Please be sure to implement safety measures to guard against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a Renesas product, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other applicable measures. Among others, since the evaluation of microcomputer software alone is very difficult, please evaluate the safety of the final products or system manufactured by you.
11. In case Renesas products listed in this document are detached from the products to which the Renesas products are attached or affixed, the risk of accident such as swallowing by infants and small children is very high. You should implement safety measures so that Renesas products may not be easily detached from your products. Renesas shall have no liability for damages arising out of such detachment.
12. This document may not be reproduced or duplicated, in any form, in whole or in part, without prior written approval from Renesas.
13. Please contact a Renesas sales office if you have any questions regarding the information contained in this document, Renesas semiconductor products, or if you have any other inquiries.